

**MAXIMUM RATINGS**

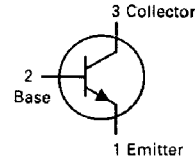
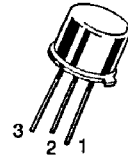
Rating	Symbol	2N3019 2N3020	2N3700	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	80	80	V <sub>dc</sub>
Collector-Base Voltage	V <sub>CBO</sub>	140	140	V <sub>dc</sub>
Emitter-Base Voltage	V <sub>EBO</sub>	7.0	7.0	V <sub>dc</sub>
Collector Current — Continuous	I <sub>C</sub>	1.0	1.0	A <sub>dc</sub>
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	0.8 4.6	0.5 2.85	Watts mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	5.0 28.6	1.8 10.6	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +200		°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	2N3019 2N3020	2N3700	Unit
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	217	350	°C/W
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	35	97	°C/W

**2N3019★  
2N3020**

CASE 79-04, STYLE 1  
TO-39 (TO-205AD)



**2N3700★**  
CASE 22-03, STYLE 1  
TO-18 (TO-206AA)



**GENERAL TRANSISTORS**

**NPN SILICON**

★2N3019 and 2N3700  
are Motorola designated  
preferred devices.

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit	
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage(1) (I <sub>C</sub> = 30 mA <sub>dc</sub> , I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	80	—	V <sub>dc</sub>	
Collector-Base Breakdown Voltage (I <sub>C</sub> = 100 μA <sub>dc</sub> , I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	140	—	V <sub>dc</sub>	
Emitter-Base Breakdown Voltage (I <sub>E</sub> = 100 μA <sub>dc</sub> , I <sub>C</sub> = 0)	V <sub>(BR)EBO</sub>	7.0	—	V <sub>dc</sub>	
Collector Cutoff Current (V <sub>CB</sub> = 90 V <sub>dc</sub> , I <sub>E</sub> = 0) (V <sub>CB</sub> = 90 V <sub>dc</sub> , I <sub>E</sub> = 0, T <sub>A</sub> = +150°C)	I <sub>CBO</sub>	—	0.01 10	μA <sub>dc</sub>	
Emitter Cutoff Current (V <sub>EB</sub> = 5.0 V <sub>dc</sub> , I <sub>C</sub> = 0)	I <sub>EBO</sub>	—	0.010	μA <sub>dc</sub>	
<b>ON CHARACTERISTICS</b>					
DC Current Gain (I <sub>C</sub> = 0.1 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> )	h <sub>FE</sub>	50 30	— 100	—	
(I <sub>C</sub> = 10 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> )(1)					2N3700, 2N3019 2N3020
(I <sub>C</sub> = 150 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> )(1)					2N3700, 2N3019 2N3020
(I <sub>C</sub> = 150 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> , T <sub>C</sub> = -55°C)(1)					2N3700, 2N3019
(I <sub>C</sub> = 500 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> )(1)					2N3700, 2N3019 2N3020
(I <sub>C</sub> = 1.0 A <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> )(1)					All Types
Collector-Emitter Saturation Voltage(1) (I <sub>C</sub> = 150 mA <sub>dc</sub> , I <sub>B</sub> = 15 mA <sub>dc</sub> ) (I <sub>C</sub> = 500 mA <sub>dc</sub> , I <sub>B</sub> = 50 mA <sub>dc</sub> )	V <sub>CE(sat)</sub>	—	0.2 0.5	V <sub>dc</sub>	
Base-Emitter Saturation Voltage(1) (I <sub>C</sub> = 150 mA <sub>dc</sub> , I <sub>B</sub> = 15 mA <sub>dc</sub> )	V <sub>BE(sat)</sub>	—	1.1	V <sub>dc</sub>	
<b>SMALL-SIGNAL CHARACTERISTICS</b>					
Current-Gain — Bandwidth Product (I <sub>C</sub> = 50 mA <sub>dc</sub> , V <sub>CE</sub> = 10 V <sub>dc</sub> , f = 20 MHz)	f <sub>T</sub>	80 100	— 400	MHz	

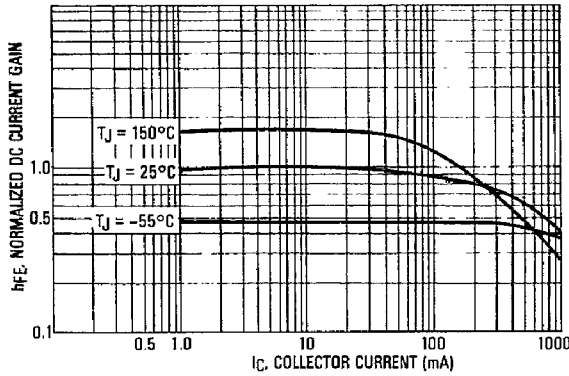
**2N3019 2N3020 2N3700**

**ELECTRICAL CHARACTERISTICS** (continued) ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

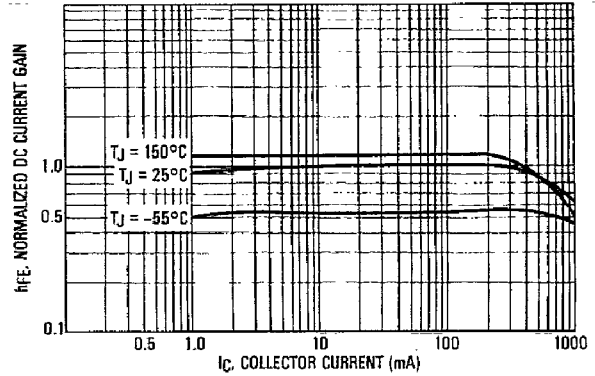
Characteristic	Symbol	Min	Max	Unit
Output Capacitance ( $V_{CB} = 10\text{ Vdc}$ , $I_E = 0$ , $f = 1.0\text{ MHz}$ )	$C_{obo}$	—	12	pF
Input Capacitance ( $V_{EB} = 0.5\text{ Vdc}$ , $I_C = 0$ , $f = 1.0\text{ MHz}$ )	$C_{ibo}$	—	60	pF
Small-Signal Current Gain ( $I_C = 1.0\text{ mAdc}$ , $V_{CE} = 5.0\text{ Vdc}$ , $f = 1.0\text{ kHz}$ )	$h_{fe}$	80 30	400 200	—
Collector Base Time Constant ( $I_E = 10\text{ mAdc}$ , $V_{CB} = 10\text{ Vdc}$ , $f = 79.8\text{ MHz}$ )	$r_b'C_c$	— 15	400 400	ps
Noise Figure ( $I_C = 100\ \mu\text{Adc}$ , $V_{CE} = 10\text{ Vdc}$ , $R_S = 1.0\text{ k ohms}$ , $f = 1.0\text{ kHz}$ )	NF	—	4	dB

(1) Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 1.0\%$ .

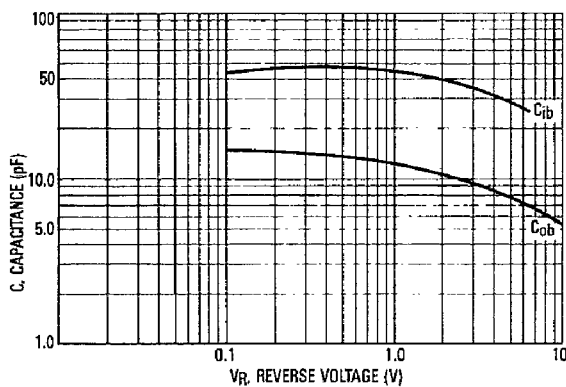
**DC CURRENT GAIN**  
2N3019, 2N3700



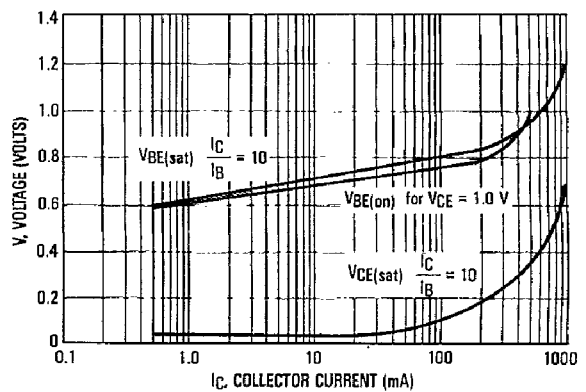
**DC CURRENT GAIN**  
2N3020



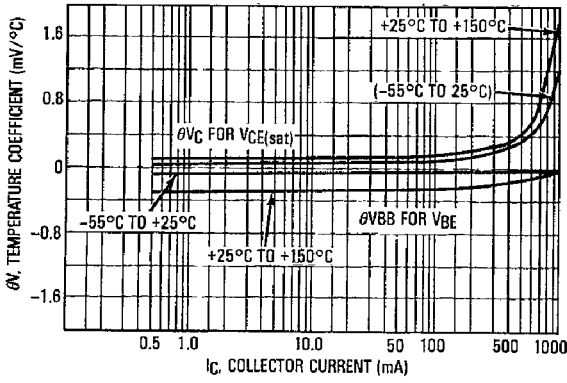
**CAPACITANCE**



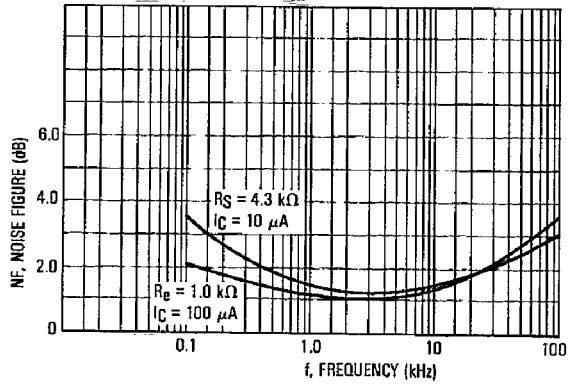
**"ON" VOLTAGES**



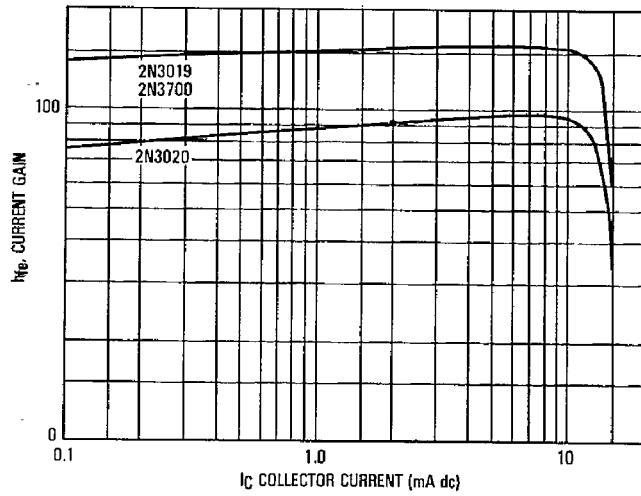
TEMPERATURE COEFFICIENTS



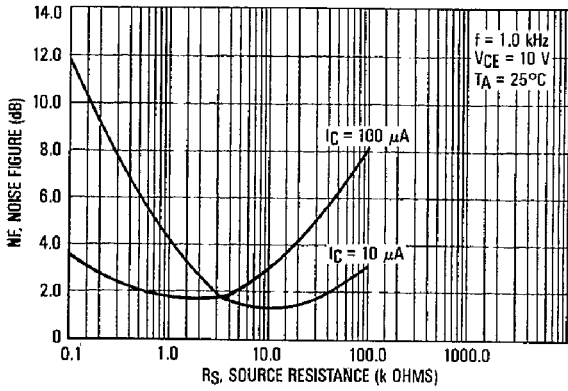
FREQUENCY EFFECTS



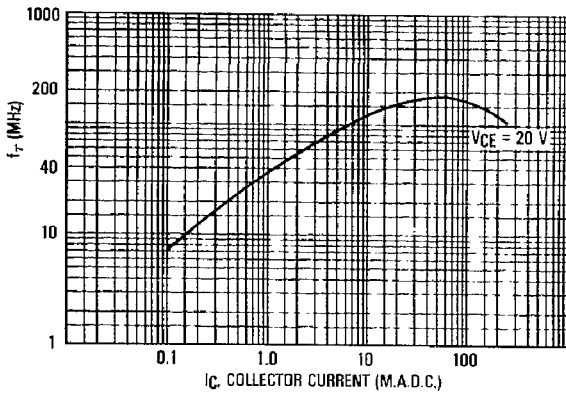
CURRENT GAIN BANDWIDTH PRODUCT versus COLLECTOR CURRENT — 1 kHz  $h_{fe}$



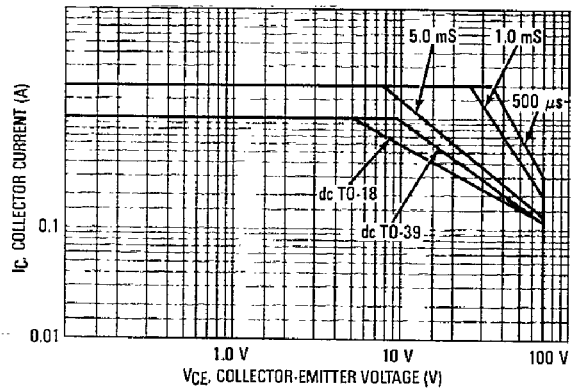
SOURCE RESISTANCE EFFECTS



CURRENT GAIN — BANDWIDTH PRODUCT

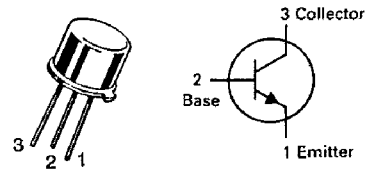


ACTIVE REGION SAFE OPERATING AREA



# 2N3053, A

CASE 79-04, STYLE 1  
TO-39 (TO-205AD)



GENERAL PURPOSE  
TRANSISTORS  
NPN SILICON

Refer to 2N3019 for graphs.

## MAXIMUM RATINGS

Rating	Symbol	2N3053	2N3053A	Unit
Collector-Emitter Voltage(1)	$V_{CEO}$	40	60	Vdc
Collector-Base Voltage	$V_{CBO}$	60	80	Vdc
Emitter-Base Voltage	$V_{EBO}$	5.0		Vdc
Collector Current — Continuous	$I_C$	700		mA dc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	5.0	28.6	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +200		$^\circ\text{C}$

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	35	$^\circ\text{C/W}$

(1) Applicable 0 to 100 mA (Pulsed);  
Pulse Width  $\leq 300 \mu\text{sec.}$ , Duty Cycle  $\leq 2.0\%$ .  
0 to 700 mA; Pulse Width  $\leq 10 \mu\text{sec.}$ , Duty Cycle  $\leq 2.0\%$ .

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Breakdown Voltage ( $I_C = 100 \mu\text{A dc}, I_B = 0$ )	$V_{(BR)CEO}$	40 60	—	Vdc
Collector-Emitter Breakdown Voltage(2) ( $I_C = 100 \text{ mA dc}, R_{BE} = 10 \text{ ohms}$ )	$V_{(BR)CER}$	50 70	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 100 \mu\text{A dc}, I_E = 0$ )	$V_{(BR)CBO}$	60 80	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 100 \mu\text{A dc}, I_C = 0$ )	$V_{(BR)EBO}$	5.0	—	Vdc
Collector Cutoff Current ( $V_{CE} = 30 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}$ ) ( $V_{CE} = 60 \text{ Vdc}, V_{EB(OFF)} = 1.5 \text{ Vdc}$ )	$I_{CEX}$	—	0.25	$\mu\text{A dc}$
Emitter Cutoff Current ( $V_{EB} = 4.0 \text{ Vdc}, I_C = 0$ )	$I_{EBO}$	—	0.25	$\mu\text{A dc}$
Base Cutoff Current ( $V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}$ )	$I_{BL}$	—	0.25	$\mu\text{A dc}$
<b>ON CHARACTERISTICS(2)</b>				
DC Current Gain ( $I_C = 150 \text{ mA dc}, V_{CE} = 2.5 \text{ Vdc}$ ) ( $I_C = 150 \text{ mA dc}, V_{CE} = 10 \text{ Vdc}$ )	$h_{FE}$	25 50	— 250	—
Collector-Emitter Saturation Voltage ( $I_C = 150 \text{ mA dc}, I_B = 15 \text{ mA dc}$ )	$V_{CE(sat)}$	—	1.4 0.3	Vdc
Base-Emitter Saturation Voltage ( $I_C = 150 \text{ mA dc}, I_B = 15 \text{ mA dc}$ )	$V_{BE(sat)}$	—	1.7 1.0	Vdc
Base-Emitter On Voltage ( $I_C = 150 \text{ mA dc}, V_{CE} = 2.5 \text{ Vdc}$ )	$V_{BE(on)}$	—	1.7 1.0	Vdc
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Current-Gain — Bandwidth Product ( $I_C = 50 \text{ mA dc}, V_{CE} = 10 \text{ Vdc}, f = 100 \text{ MHz}$ )	$f_T$	100	—	MHz
Output Capacitance ( $V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$ )	$C_{obo}$	—	15	pF
Input Capacitance ( $V_{EB} = 0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz}$ )	$C_{ibo}$	—	80	pF

(2) Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .